

## **Application for Higher Education Scholarship for Children of Deceased or Disabled Ministers**

PERSONAL INFORMATION							
Students Name (last, first, middle initial)			Date of birth (mm/dd/yr) Name of deceased or disabled clerg				eceased or disabled clergy parent
			/ /				
Address (number and street)			City/State/ZIP				
· ·			•				
T.11			E-mail address				
Telephone number (with area code)			E-mail address				
( ) –			@				
CHURCH MEMBERSHIP							
Name/address of church of which you are a member							
D. L.M.	D 1 T 1						
Pastor's Name	Pastor's Tel	or's Telephone (with area co			Pastor's	E-mail add	ress
	( )		-				@
SCHOOL INFORMATION							
Name/address of school you will attend (please attach proof of enroll			lment)				Start Date (mm/dd/yr)
Degree program Expected			d year of graduation			Status	
			,				☐ Full-time ☐ Part-time
FINANCIAL INFORMATION							
FINANCIAL INFORMATION							
Tuition per semester				\$			
Room and board per semester				\$			
Toom and board per semester				۳			
Books and supplies per semester		\$					
				<u> </u>			
Other costs (i.e., transportation) per semester				\$			
Miscellaneous fees (Please Describe)							
				\$			
				Ψ			
Will you receive any other scholarship(s) or financial aid? $\Box$ Yes $\Box$ No				_			
If yes, please indicate the amount in the space provided at right.				\$			
STUDENT SIGNATURE							
Student signature				D	ate		
When you have completed the application, please send it to your Conference Minister for review and endorsement. It is the student's responsibility to make sure the Conference Minister returns the form directly to the Pension Boards.							
CONFERENCE ENDORSEMENT							
I hereby endorse this application for a Higher Education Scholarship.							
Student signature				D	ate		

## **Note to Conference Minister:**

If you endorse this application for Higher Education Scholarship, please sign, date and return the form to the Pension Boards at the attention of Director of Ministerial Assistance at the address indicated below.

HES App 5-2019